

Programmable FTG for Differential CPU, PCI Express* & SATA Clocks

Recommended Application:

Frequency Timing Generator for Differential CPU, PCI Express & SATA clocks

Features:

- Generates common CPU/PCI Express frequencies from 14.318 MHz or 25 MHz
- Crystal or reference input
- 7 - 0.7V current-mode differential output pairs
- 3 - 33MHz PCI outputs
- 1 - REFOUT
- Supports Serial-ATA at 100 MHz
- Two spread spectrum modes: 0 to -0.5 downspread and +/-0.25% centerspread
- Unused inputs may be disabled in either driven or Hi-Z state for power management.

Key Specifications:

- Output cycle-to-cycle jitter for DIF outputs < 50 ps (<85ps @ 266 MHz)
- Output to output skew for DIF outputs < 85 ps
- +/-300 ppm frequency accuracy on output clocks

Frequency Select Table

SEL14M_25M# (FS3)	FS2	FS1	FS0	OUTPUT(MHz)
0	0	0	0	100.00
0	0	0	1	125.00
0	0	1	0	133.33
0	0	1	1	166.67
0	1	0	0	200.00
0	1	0	1	266.66
0	1	1	0	333.33
0	1	1	1	400.00
1	0	0	0	100.00
1	0	0	1	125.00
1	0	1	0	133.33
1	0	1	1	166.67
1	1	0	0	200.00
1	1	0	1	266.66
1	1	1	0	333.33
1	1	1	1	400.00

Pin Configuration

XIN/CLKIN	1	48	VDDA
X2	2	47	GNDA
VDD	3	46	IREF
GND	4	45	*DWNSPRD#
*FS2/REFOUT	5	44	**FS1
GND	6	43	*OE_0
*FS0/PCICLK_F	7	42	DIF_0
PCICLK0	8	41	DIF_0#
PCICLK1	9	40	VDD
VDD	10	39	DIF_1
**OE_6	11	38	DIF_1#
DIF_6	12	37	**OE_1
DIF_6#	13	36	VDD
VDD	14	35	GND
GND	15	34	**OE_2
**OE_5	16	33	DIF_2
DIF_5	17	32	DIF_2#
DIF_5#	18	31	VDD
VDD	19	30	DIF_3
DIF_4	20	29	DIF_3#
DIF_4#	21	28	*OE_3
*OE_4	22	27	**SEL14M_25M#
SDATA	23	26	*SPREAD
SCLK	24	25	DIF_STOP#

ICS9FG107

48-pin SSOP & TSSOP

Notes:

- Pins preceded by * have 120 Kohm pull DOWN resistors
- Pins preceded by ** have 120 Kohm pull UP resistors

Pin Description

PIN #	PIN NAME	PIN TYPE	DESCRIPTION
1	XIN/CLKIN	IN	Crystal input or Reference Clock input
2	X2	OUT	Crystal output, Nominally 14.318MHz
3	VDD	PWR	Power supply, nominal 3.3V
4	GND	PWR	Ground pin.
5	*FS2/REFOUT	I/O	Frequency select latch input pin / Reference clock output
6	GND	PWR	Ground pin.
7	*FS0/PCICLK_F	I/O	Frequency select latch input pin / 3.3V PCI free running clock output.
8	PCICLK0	OUT	PCI clock output.
9	PCICLK1	OUT	PCI clock output.
10	VDD	PWR	Power supply, nominal 3.3V
11	**OE_6	IN	Active high input for enabling outputs. 0 = tri-state outputs, 1= enable outputs
12	DIF_6	OUT	0.7V differential true clock outputs
13	DIF_6#	OUT	0.7V differential complement clock outputs
14	VDD	PWR	Power supply, nominal 3.3V
15	GND	PWR	Ground pin.
16	**OE_5	IN	Active high input for enabling outputs. 0 = tri-state outputs, 1= enable outputs
17	DIF_5	OUT	0.7V differential true clock outputs
18	DIF_5#	OUT	0.7V differential complement clock outputs
19	VDD	PWR	Power supply, nominal 3.3V
20	DIF_4	OUT	0.7V differential true clock outputs
21	DIF_4#	OUT	0.7V differential complement clock outputs
22	*OE_4	IN	Active high input for enabling outputs. 0 = tri-state outputs, 1= enable outputs
23	SDATA	I/O	Data pin for SMBus circuitry, 5V tolerant.
24	SCLK	IN	Clock pin of SMBus circuitry, 5V tolerant.

Pin Description (Continued)

PIN #	PIN NAME	PIN TYPE	DESCRIPTION
25	DIF_STOP#	IN	Active low input to stop differential output clocks.
26	*SPREAD	IN	Asynchronous, active high input, with internal 120Kohm pull-up resistor, to enable spread spectrum functionality.
27	**SEL14M_25M#	IN	Select 14.31818 MHz or 25 Mhz input frequency. 1 = 14.31818 MHz, 0 = 25 MHz
28	*OE_3	IN	Active high input for enabling outputs. 0 = tri-state outputs, 1= enable outputs
29	DIF_3#	OUT	0.7V differential complement clock outputs
30	DIF_3	OUT	0.7V differential true clock outputs
31	VDD	PWR	Power supply, nominal 3.3V
32	DIF_2#	OUT	0.7V differential complement clock outputs
33	DIF_2	OUT	0.7V differential true clock outputs
34	**OE_2	IN	Active high input for enabling outputs. 0 = tri-state outputs, 1= enable outputs
35	GND	PWR	Ground pin.
36	VDD	PWR	Power supply, nominal 3.3V
37	**OE_1	IN	Active high input for enabling outputs. 0 = tri-state outputs, 1= enable outputs
38	DIF_1#	OUT	0.7V differential complement clock outputs
39	DIF_1	OUT	0.7V differential true clock outputs
40	VDD	PWR	Power supply, nominal 3.3V
41	DIF_0#	OUT	0.7V differential complement clock outputs
42	DIF_0	OUT	0.7V differential true clock outputs
43	*OE_0	IN	Active high input for enabling outputs. 0 = tri-state outputs, 1= enable outputs
44	**FS1	I/O	Frequency select latch input pin / 3.3V 66.66MHz clock output.
45	*DWNSPRD#	IN	3.3V input that selects spread mode. This input is not latched at power up. 0 = Down Spread, 1 = Center Spread
46	IREF	OUT	This pin establishes the reference current for the differential current-mode output pairs. This pin requires a fixed precision resistor tied to ground in order to establish the appropriate current. 475 ohms is the standard value.
47	GNDA	PWR	Ground pin for the PLL core.
48	VDDA	PWR	3.3V power for the PLL core.

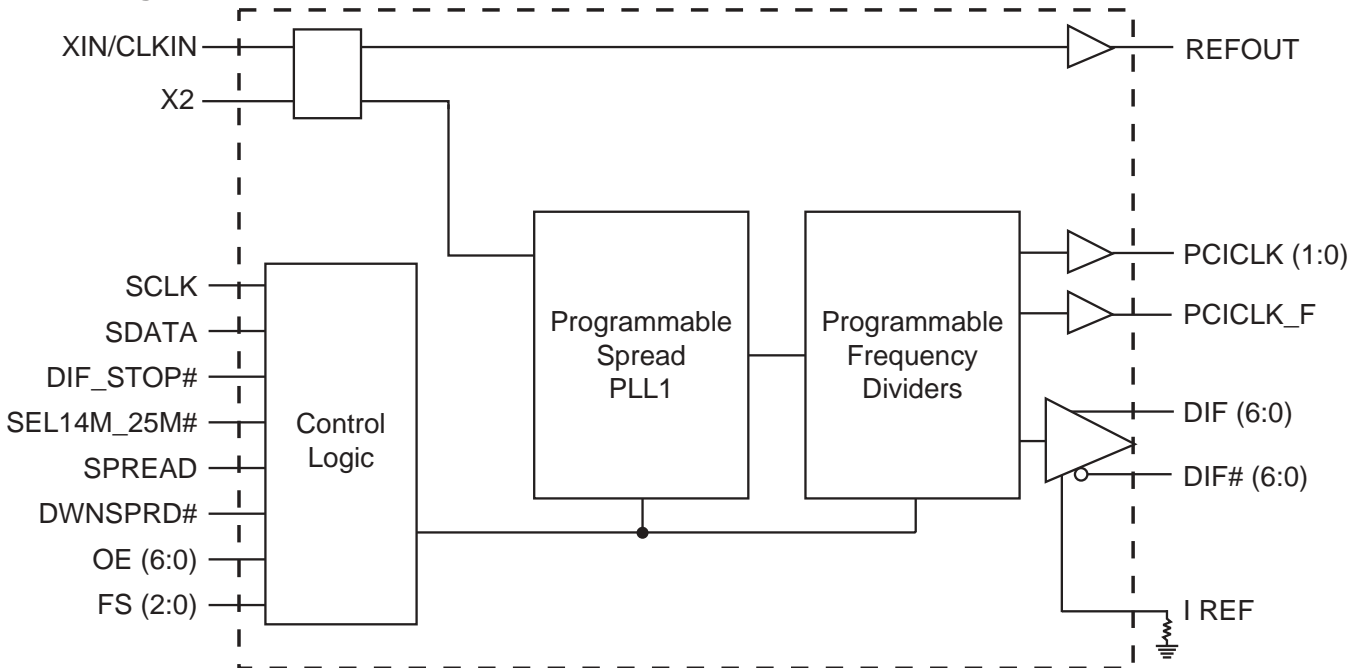
Pins preceded by * have 120 Kohm pull DOWN resistors

Pins preceded by ** have 120 Kohm pull UP resistors

General Description

ICS9FG107 is a Frequency Timing Generator that provides 7 differential output pairs that are compliant to the Intel CK409/CK410 specification. It provides support for PCI-Express, next generation I/O, and SATA. The part synthesizes several output frequencies from either a 14.31818 Mhz crystal or a 25 MHz crystal. The device can also be driven by a reference input clock instead of a crystal. It provides outputs with cycle-to-cycle jitter of less than 85 ps and output-to-output skew of less than 85 ps. **ICS9FG107** also provides a copy of the reference clock and 3 33 MHz PCI output clocks. Frequency selection can be accomplished via strap pins or SMBus control.

Block Diagram



Power Groups

Pin Number		Description
VDD	GND	
3	4	REFOUT, Digital Inputs, SMBus
10	6	PCI Outputs
14,19,31,36,40	15,35	DIF Outputs
N/A	47	IREF
48	47	Analog VDD & GND for PLL Core

Absolute Max

Symbol	Parameter	Min	Max	Units
VDD_A	3.3V Core Supply Voltage		$V_{DD} + 0.5V$	V
VDD_In	3.3V Logic Input Supply Voltage	GND - 0.5	$V_{DD} + 0.5V$	V
Ts	Storage Temperature	-65	150	°C
Tambient	Ambient Operating Temp	0	70	°C
Tcase	Case Temperature		115	°C
ESD prot	Input ESD protection human body model	2000		V

Electrical Characteristics - Input/Supply/Common Output Parameters

$T_A = 0 - 70^\circ\text{C}$; Supply Voltage $V_{DD} = 3.3\text{ V} \pm 5\%$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Input High Voltage	V_{IH}	3.3 V +/-5%	2		$V_{DD} + 0.3$	V	
Input Low Voltage	V_{IL}	3.3 V +/-5%	$V_{SS} - 0.3$		0.8	V	
Input High Current	I_{IH}	$V_{IN} = V_{DD}$	-5		5	uA	
Input Low Current	I_{IL1}	$V_{IN} = 0\text{ V}$; Inputs with no pull-up resistors	-5			uA	
	I_{IL2}	$V_{IN} = 0\text{ V}$; Inputs with pull-up resistors	-200			uA	
Operating Supply Current	$I_{DD3.3OP}$	Full Active, $C_L = \text{Full load}$; $f = 400\text{ MHz}$			250	mA	
		Full Active, $C_L = \text{Full load}$; $f = 100\text{ MHz}$			200	mA	
Input Frequency ³	F_i	$V_{DD} = 3.3\text{ V}$	14		25	MHz	3
Pin Inductance ¹	L_{pin}				7	nH	1
Input/Output Capacitance ¹	C_{IN}	Logic Inputs	1.5		5	pF	1
	C_{OUT}	Output pin capacitance			6	pF	1
Clk Stabilization ^{1,2}	T_{STAB}	From V_{DD} Power-Up and after input clock stabilization to 1st clock			1.8	ms	1,2
Modulation Frequency	f_{MOD}	Triangular Modulation	30		40	kHz	1
DIF output enable	t_{DIFOE}	DIF output enable after DIF_Stop# de-assertion			10	ns	1
Input Rise and Fall times	t_R/t_F	20% to 80% of VDD			5	ns	1

¹Guaranteed by design and characterization, not 100% tested in production.

²See timing diagrams for timing requirements.

³Input frequency should be measured at the REFOUT pin and tuned to ideal 14.31818MHz or 25 MHz to meet ppm frequency accuracy on PLL outputs.

Electrical Characteristics - DIF 0.7V Current Mode Differential Pair

$T_A = 0 - 70^\circ\text{C}$; $V_{DD} = 3.3\text{ V} \pm 5\%$; $C_L = 2\text{pF}$, $R_S = 33.2\Omega$, $R_P = 49.9\Omega$ $V_{REF} \angle 0^\circ$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Current Source Output Impedance	Z_o^1	$V_O = V_x$	3000			\angle	1
Voltage High	VHigh	Statistical measurement on single ended signal using oscilloscope math function.	660		850	mV	1
Voltage Low	VLow		-150		150		1
Max Voltage	Vovs	Measurement on single ended signal using absolute value.			1150	mV	1
Min Voltage	Vuds		-300				1
Crossing Voltage (abs)	Vcross(abs)		250		550	mV	1
Crossing Voltage (var)	d-Vcross	Variation of crossing over all edges			140	mV	1
Long Accuracy	ppm	see Tperiod min-max values	-300		300	ppm	1,2
Average period	Tperiod	400MHz nominal	2.4993		2.5008	ns	2
		400MHz spread	2.4993		2.5133	ns	2,3
		333.33MHz nominal	2.9991		3.0009	ns	2
		333.33MHz spread	2.9991		3.016	ns	2,3
		266.66MHz nominal	3.7489		3.7511	ns	2
		266.66MHz spread	3.7489		3.77	ns	2,3
		200MHz nominal	4.9985		5.0015	ns	2
		200MHz spread	4.9985		5.0266	ns	2,3
		166.66MHz nominal	5.9982		6.0018	ns	2
		166.66MHz spread	5.9982		6.0320	ns	2,3
		133.33MHz nominal	7.4978		7.5023	ns	2
		133.33MHz spread	7.4978		5.4000	ns	2,3
		100.00MHz nominal	9.9970		10.0030	ns	2
		100.00MHz spread	9.9970		10.0533	ns	2,3
Absolute min period	T _{absmin}	400MHz nominal/spread	2.4143			ns	1,2
		333.33MHz nominal/spread	2.9141			ns	1,2
		266.66MHz nominal/spread	3.6639			ns	1,2
		200MHz nominal/spread	4.8735			ns	1,2
		166.66MHz nominal/spread	5.8732			ns	1,2
		133.33MHz nominal/spread	7.3728			ns	1,2
		100.00MHz nominal/spread	9.8720			ns	1,2
Rise Time	t_r	$V_{OL} = 0.175\text{V}$, $V_{OH} = 0.525\text{V}$	175		700	ps	1
Fall Time	t_f	$V_{OH} = 0.525\text{V}$ $V_{OL} = 0.175\text{V}$	175		700	ps	1
Rise Time Variation	d- t_r				125	ps	1
Fall Time Variation	d- t_f				125	ps	1
Duty Cycle	d_{t3}	Measurement from differential waveform	45		55	%	1
Skew	t_{sk3}	$V_T = 50\%$			85	ps	1
Jitter, Cycle to cycle	$t_{jyc-cyc}$	Measurement from differential waveform f not equal 266 MHz			50	ps	1
		Measurement from differential waveform f = 266 MHz			85	ps	1

¹Guaranteed by design and characterization, not 100% tested in production.

² All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REFOUT is at 14.31818MHz or 25 MHz

³ Figures are for down spread.

Electrical Characteristics - PCICLK/PCICLK_F

$T_A = 0 - 70^\circ\text{C}$; $V_{DD} = 3.3\text{ V} \pm 5\%$; $C_L = 30\text{ pF}$ (unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	Notes
Long Accuracy	ppm	see Tperiod min-max values	-300		300	ppm	1,2
Clock period	T_{period}	33.33MHz output nominal	29.99100		30.00900	ns	2
		33.33MHz output spread	29.99100		30.15980	ns	2
Absolute Min/Max Clock period	T_{abs}	33.33MHz output nominal	29.49100		30.50900	ns	2
		33.33MHz output spread	29.49100		30.65980	ns	2
Clk High Time	t_{h1}		12		N/A	ns	1
Clock Low Time	t_{l1}		12		N/A	ns	1
Output High Voltage	V_{OH}	$I_{OH} = -1\text{ mA}$	2.4			V	
Output Low Voltage	V_{OL}	$I_{OL} = 1\text{ mA}$			0.55	V	
Output High Current	I_{OH}	$V_{OH} @ \text{MIN} = 1.0\text{ V}$	-33			mA	
		$V_{OH} @ \text{MAX} = 3.135\text{ V}$			-33	mA	
Output Low Current	I_{OL}	$V_{OL} @ \text{MIN} = 1.95\text{ V}$	30			mA	
		$V_{OL} @ \text{MAX} = 0.4\text{ V}$			38	mA	
Edge Rate		Rising edge rate	1		4	V/ns	1
Edge Rate		Falling edge rate	1		4	V/ns	1
Rise Time	t_{r1}	$V_{OL} = 0.4\text{ V}, V_{OH} = 2.4\text{ V}$	0.5	1.4	2	ns	1
Fall Time	t_{f1}	$V_{OH} = 2.4\text{ V}, V_{OL} = 0.4\text{ V}$	0.5	1.4	2	ns	1
Duty Cycle	d_{t1}	$V_T = 1.5\text{ V}$	45		55	%	1
Skew	t_{sk1}	$V_T = 1.5\text{ V}$			500	ps	1
Jitter	$t_{j\text{cyc-cyc}}$	$V_T = 1.5\text{ V}$			250	ps	1

¹Guaranteed by design, not 100% tested in production.

²All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REFOUT is at 14.31818MHz or 25 MHz

Electrical Characteristics - REF-14.318/25 MHz

$T_A = 0 - 70^\circ\text{C}$; $V_{DD} = 3.3\text{ V} \pm 5\%$; $C_L = 10\text{-}20\text{ pF}$ (unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	Notes
Long Accuracy	ppm	see Tperiod min-max values	-300	0	300	ppm	1
Clock period	T_{period}	14.318MHz output nominal	69.8270	69.8413	69.8550	ns	1,2
		25.000MHz output nominal	39.9880	40.0000	40.0120	ns	1,2
Output High Voltage	V_{OH}	$I_{OH} = -1\text{ mA}$	2.4			V	1
Output Low Voltage	V_{OL}	$I_{OL} = 1\text{ mA}$			0.4	V	1
Output High Current	I_{OH}	$V_{OH} @ \text{MIN} = 1.0\text{ V},$ $V_{OH} @ \text{MAX} = 3.135\text{ V}$	-29		-23	mA	1
Output Low Current	I_{OL}	$V_{OL} @ \text{MIN} = 1.95\text{ V},$ $V_{OL} @ \text{MAX} = 0.4\text{ V}$	29		27	mA	1
Rise Time	t_{r1}	$V_{OL} = 0.4\text{ V}, V_{OH} = 2.4\text{ V}$	1	1.6	2	ns	1
Fall Time	t_{f1}	$V_{OH} = 2.4\text{ V}, V_{OL} = 0.4\text{ V}$	1	1.6	2	ns	1
Duty Cycle	d_{t1}	$V_T = 1.5\text{ V}$	45		55	%	1
Jitter	$t_{j\text{cyc-cyc}}$	$V_T = 1.5\text{ V}$		160	250	ps	1

¹Guaranteed by design and characterization, not 100% tested in production.

²All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REFOUT is at 14.31818 or 25.00 MHz

General SMBus serial interface information for the ICS9FG107

How to Write:

- Controller (host) sends a start bit.
- Controller (host) sends the write address $DC_{(H)}$
- ICS clock will **acknowledge**
- Controller (host) sends the beginning byte location = N
- ICS clock will **acknowledge**
- Controller (host) sends the data byte count = X
- ICS clock will **acknowledge**
- Controller (host) starts sending **Byte N through Byte N + X - 1**
(see Note 2)
- ICS clock will **acknowledge** each byte **one at a time**
- Controller (host) sends a Stop bit

How to Read:

- Controller (host) will send start bit.
- Controller (host) sends the write address $DC_{(H)}$
- ICS clock will **acknowledge**
- Controller (host) sends the beginning byte location = N
- ICS clock will **acknowledge**
- Controller (host) will send a separate start bit.
- Controller (host) sends the read address $DD_{(H)}$
- ICS clock will **acknowledge**
- ICS clock will send the data byte count = X
- ICS clock sends **Byte N + X - 1**
- ICS clock sends **Byte 0 through byte X (if $X_{(H)}$ was written to byte 8).**
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

Index Block Write Operation		
Controller (Host)		ICS (Slave/Receiver)
T	starT bit	
Slave Address $DC_{(H)}$		
WR	WRite	
		ACK
Beginning Byte = N		
		ACK
Data Byte Count = X		
		ACK
Beginning Byte N		X Byte
○		
○		
○		
○		
Byte N + X - 1		
		ACK
P	stoP bit	

Index Block Read Operation			
Controller (Host)		ICS (Slave/Receiver)	
T	starT bit		
Slave Address $DC_{(H)}$			
WR	WRite		
		ACK	
Beginning Byte = N			
		ACK	
RT	Repeat starT		
Slave Address $DD_{(H)}$			
RD	ReaD		
		ACK	
		Data Byte Count = X	
ACK			
ACK		X Byte	
			Beginning Byte N
○			
○			
○			
○		Byte N + X - 1	
N	Not acknowledge		
P	stoP bit		



I²C Table: Device Control Register, READ/WRITE ADDRESS (DC/DD)

Byte 0		Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	27		FS3 ¹		RW	See Frequency Selection Table, Page 1		Pin 27
Bit 6	5		FS2 ¹		RW			Pin 5
Bit 5	44		FS1 ¹		RW			Pin 44
Bit 4	7		FS0 ¹		RW			Pin 7
Bit 3	26		Spread Enable ¹		RW	Off	On	Pin 26
Bit 2	-		Enable Software Control of Frequency, Spread Enable and Spread Type		RW	Hardware Select	Software Select	0
Bit 1			DIF_STOP# drive mode		RW	Driven	Hi-Z	0
Bit 0	45		DWNSPRD# ¹		RW	Down	Center	Pin 45

Notes:

1. These bits reflect the latched state of the corresponding pins at power up, but may be written to if Byte 0, bit 2 is set to '1'. FS3 is the SEL14M_25M# pin.

I²C Table: Output Enable Register

Byte 1		Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	8		PCICLK0	Output Enable	RW	Stop Low	Enable	1
Bit 6	12,13		DIF_6	Output Enable	RW	Disable	Enable	1
Bit 5	17,18		DIF_5	Output Enable	RW	Disable	Enable	1
Bit 4	20,21		DIF_4	Output Enable	RW	Disable	Enable	1
Bit 3	30,29		DIF_3	Output Enable	RW	Disable	Enable	1
Bit 2	33,32		DIF_2	Output Enable	RW	Disable	Enable	1
Bit 1	39,38		DIF_1	Output Enable	RW	Disable	Enable	1
Bit 0	42,41		DIF_0	Output Enable	RW	Disable	Enable	1

I²C Table: Output Stop Mode Register

Byte 2		Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	9		PCICLK1	Output Enable	RW	Stop Low	Enable	1
Bit 6	12,13		DIF_6	Stop Mode	RW	Free-run	Stop-able	0
Bit 5	17,18		DIF_5	Stop Mode	RW	Free-run	Stop-able	0
Bit 4	20,21		DIF_4	Stop Mode	RW	Free-run	Stop-able	0
Bit 3	30,29		DIF_3	Stop Mode	RW	Free-run	Stop-able	0
Bit 2	33,32		DIF_2	Stop Mode	RW	Free-run	Stop-able	0
Bit 1	39,38		DIF_1	Stop Mode	RW	Free-run	Stop-able	0
Bit 0	42,41		DIF_0	Stop Mode	RW	Free-run	Stop-able	0

I²C Table: Frequency Select Readback Register

Byte 3		Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	27		SEL14M_25M# ¹ (FS3)	State of pin 27	R	See Frequency Selection Table, Page 1		Pin 27
Bit 6	5		FS2 ¹	State of pin 6	R			Pin 5
Bit 5	44		FS1 ¹	State of pin 44	R			Pin 44
Bit 4	7		FS0 ¹	State of pin 7	R			Pin 7
Bit 3	26		SPREAD ¹	State of pin 26	R	Off	On	Pin 26
Bit 2			RESERVED		R	RESERVED		X
Bit 1			RESERVED		R	RESERVED		X
Bit 0	45		DWNSPRD ¹	State of pin 45	R	Down	Center	Pin 45

Notes:

1. These read-only bits always reflect the latched state of the corresponding pins at power up.

I²C Table: Vendor & Revision ID Register

Byte 4		Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-		RID3	REVISION ID	R	-	-	0
Bit 6	-		RID2		R	-	-	0
Bit 5	-		RID1		R	-	-	0
Bit 4	-		RID0		R	-	-	0
Bit 3	-		VID3	VENDOR ID	R	-	-	0
Bit 2	-		VID2		R	-	-	0
Bit 1	-		VID1		R	-	-	0
Bit 0	-		VID0		R	-	-	1

I²C Table: DEVICE ID

Byte 5		Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-		Device ID = 07 Hex Bit 7 is MSB		R	RESERVED		0
Bit 6	-				R	RESERVED		0
Bit 5	-				R	RESERVED		0
Bit 4	-				R	RESERVED		0
Bit 3	-				R	RESERVED		0
Bit 2	-				R	RESERVED		1
Bit 1	-				R	RESERVED		1
Bit 0	-				R	RESERVED		1

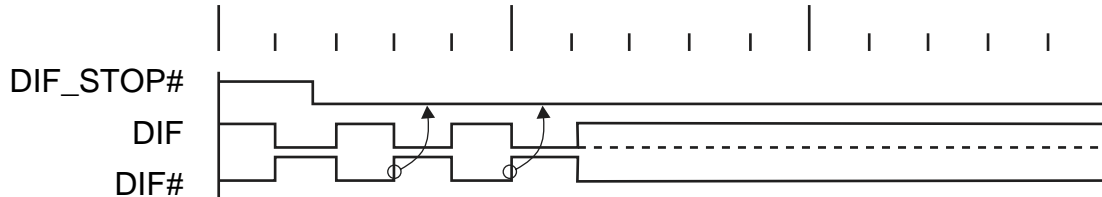


I²C Table: Byte Count Register

Byte 6		Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-		BC7	Writing to this register will configure how many bytes will be read back, default is 07 = 7 bytes.	RW	-	-	0
Bit 6	-		BC6		RW	-	-	0
Bit 5	-		BC5		RW	-	-	0
Bit 4	-		BC4		RW	-	-	0
Bit 3	-		BC3		RW	-	-	0
Bit 2	-		BC2		RW	-	-	1
Bit 1	-		BC1		RW	-	-	1
Bit 0	-		BC0		RW	-	-	1

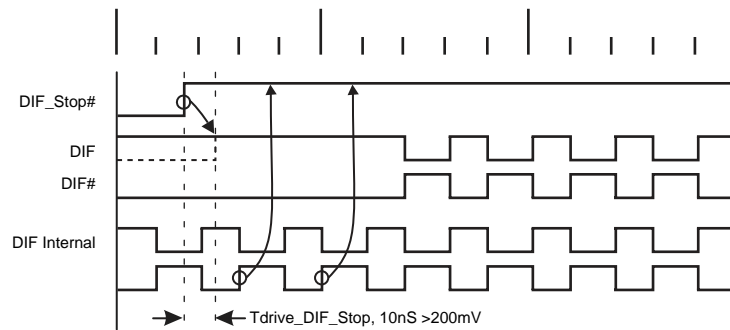
DIF_STOP# - Assertion (transition from '1' to '0')

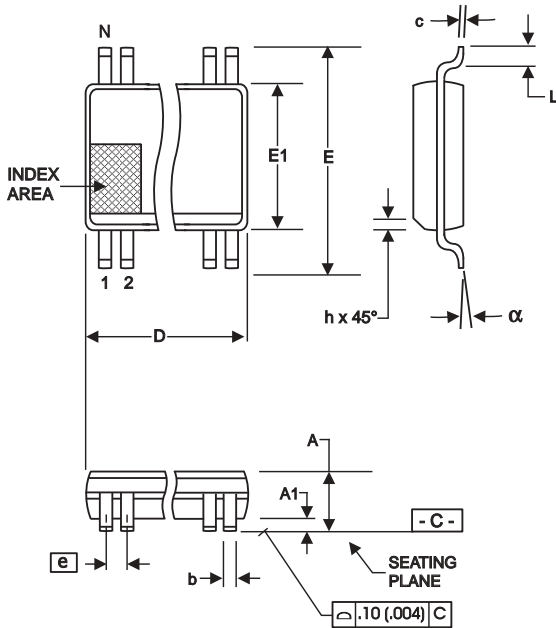
Asserting DIF_STOP# pin stops all DIF outputs that are set to be stoppable after their next transition. When the I2C DIF_STOP tri-state bit corresponding to the DIF output of interest is programmed to a '0', DIF output will stop DIF_True = HIGH and DIF_Complement = LOW. When the I2C DIF_STOP tri-state bit corresponding to the DIF output of interest is programmed to a '1', DIF outputs will be tri-stated.



DIF_STOP# - De-assertion (transition from '0' to '1')

With the de-assertion of DIF_STOP# all stopped DIF outputs will resume without a glitch. The maximum latency from the de-assertion to active outputs is 2 - 6 DIF clock periods. If the control register tristate bit corresponding to the output of interest is programmed to '1', then the stopped DIF outputs will be driven High within 10nS of DIF_Stop# de-assertion to a voltage greater than 200mV.





SYMBOL	In Millimeters COMMON DIMENSIONS		In Inches COMMON DIMENSIONS	
	MIN	MAX	MIN	MAX
A	2.41	2.80	.095	.110
A1	0.20	0.40	.008	.016
b	0.20	0.34	.008	.0135
c	0.13	0.25	.005	.010
D	SEE VARIATIONS		SEE VARIATIONS	
E	10.03	10.68	.395	.420
E1	7.40	7.60	.291	.299
e	0.635 BASIC		0.025 BASIC	
h	0.38	0.64	.015	.025
L	0.50	1.02	.020	.040
N	SEE VARIATIONS		SEE VARIATIONS	
alpha	0°	8°	0°	8°

VARIATIONS

N	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
48	15.75	16.00	.620	.630

Reference Doc.: JEDEC Publication 95, MO-118

10-0034

Ordering Information

ICS9FG107yFLFT

Example:

ICS XXXX y F Lx T

**Designation for tape and reel packaging
Lead Option (optional)**

LF = Lead Free

LN = Lead Free Annealed

Package Type

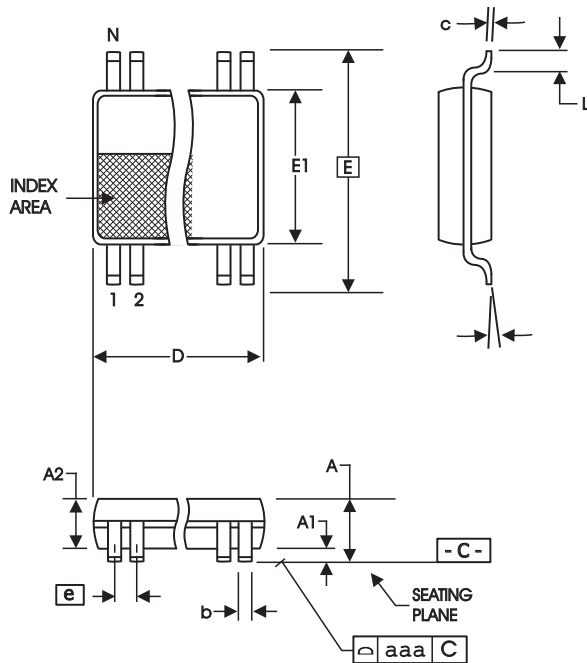
F = SSOP

Revision Designator (will not correlate with datasheet revision)

Device Type (consists of 3 or 4 digit numbers)

Prefix

ICS, AV = Standard Device



48-Lead, 6.10 mm. Body, 0.50 mm. Pitch TSSOP
(240 mil) (20 mil)

SYMBOL	In Millimeters COMMON DIMENSIONS		In Inches COMMON DIMENSIONS	
	MIN	MAX	MIN	MAX
A	--	1.20	--	.047
A1	0.05	0.15	.002	.006
A2	0.80	1.05	.032	.041
b	0.17	0.27	.007	.011
c	0.09	0.20	.0035	.008
D	SEE VARIATIONS		SEE VARIATIONS	
E	8.10 BASIC		0.319 BASIC	
E1	6.00	6.20	.236	.244
e	0.50 BASIC		0.020 BASIC	
L	0.45	0.75	.018	.030
N	SEE VARIATIONS		SEE VARIATIONS	
a	0°	8°	0°	8°
aaa	--	0.10	--	.004

VARIATIONS

N	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
48	12.40	12.60	.488	.496

Reference Doc.: JEDEC Publication 95, MO-153

10-0039

Ordering Information

ICS9FG107yGLFT

Example:

ICS XXXX y G Lx T

Designation for tape and reel packaging
Lead Option (optional)

LF = Lead Free
LN = Lead Free Annealed

Package Type
G = TSSOP

Revision Designator (will not correlate with datasheet revision)

Device Type (consists of 3 or 4 digit numbers)

Prefix

ICS, AV = Standard Device